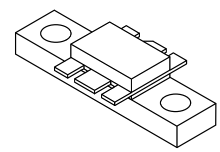
The RF Line
NPN Silicon RF Power Transistor

MRF894

. . . designed for 24 volt UHF large–signal, common–base amplifier applications in industrial and commercial FM equipment operating in the range of 804–960 MHz.

- Specified 24 Volt, 900 MHz Characteristics
  Output Power = 30 Watts
  Power Gain = 7.0 dB Min
  Efficiency = 55% Min
- Series Equivalent Large–Signal Characterization
- Capable of 30:1 VSWR Load Mismatch at Rated Output Power and Supply Voltage
- Gold Metallized, Emitter Ballasted for Long Life and Resistance to Metal Migration
- Silicon Nitride Passivated

**30 W, 900 MHz
RF POWER
TRANSISTOR
NPN SILICON**



CASE 319–07, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	30	Vdc
Collector–Base Voltage	V_{CBO}	50	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	7.0	Adc
Total Device Dissipation @ T_C = 25°C (1) Derate above 25°C	P_D	115 0.66	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (2)	$R_{\theta JC}$	1.5	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

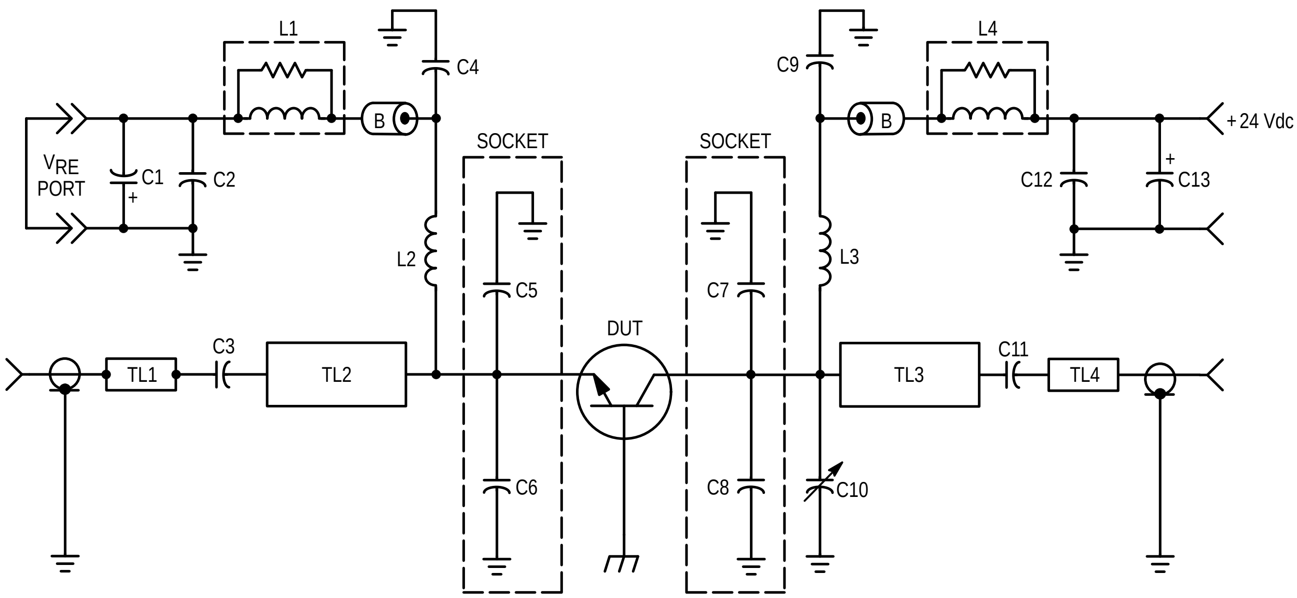
Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 25 mAdc, I_B = 0)	$V_{(BR)CEO}$	30	—	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 25 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	50	—	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 5.0 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current (V_{CB} = 30 Vdc, I_E = 0)	I_{CBO}	—	—	10	mAdc

(continued)

NOTES:
1. This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.
2. Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques.

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain (I_C = 2.0 Adc, V_{CE} = 5.0 Vdc)	h_{FE}	10	—	120	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 30 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	45	—	pF
FUNCTIONAL TESTS					
Common–Base Amplifier Power Gain (P_{out} = 30 W, V_{CC} = 24 Vdc, f = 900 MHz)	G_{PE}	7.0	8.5	—	dB
Collector Efficiency (P_{out} = 30 W, V_{CC} = 24 Vdc, f = 900 MHz)	η	55	60	—	%



B — Ferrite Bead, Ferroxcube 56–590–65–3B
C1, C13 — 5.0 µF, 50 Vdc
C2, C12 — 1000 pF Unelco
C3, C11 — 47 pF, 100 Mil Chip Capacitor
C4, C9 — 91 pF, Mini–Underwood
C5, C6 — 12 pF, Mini–Underwood
C7 — 18 pF, Mini–Underwood
C8 — 24 pF, Mini–Underwood
C10 — 0.8 – 8.0 pF Johanson Gigatrim

L1, L4 — 11 Turns #20 Enameled Over 10 Ω Carbon Resistor
L2, L3 — 4 Turns #20 Enameled, .15″ ID
TL1, TL4 — Micro Strip Line, 50 Ω
TL2 — Micro Strip, Z_o = 30 Ω, λ/4 @ 875 MHz
TL3 — Micro Strip, Z_o = 22 Ω, λ/4 @ 875 MHz
Board — 0.032″ Glass Teflon
2 oz. Cu CLAD, ε_r = 2.55

Figure 1. 850 – 900 MHz Broadband Circuit Schematic

TYPICAL CHARACTERISTICS

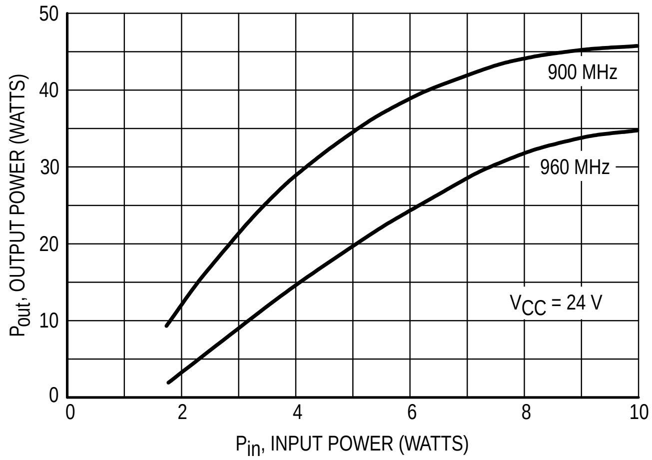


Figure 2. Output Power versus Input Power

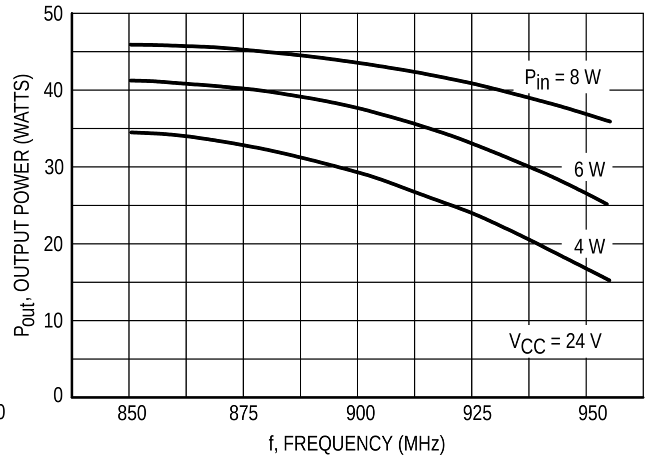


Figure 3. Output Power versus Frequency

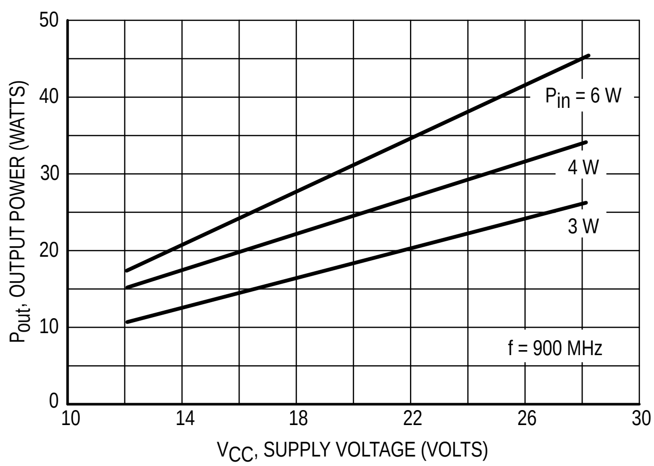


Figure 4. Output Power versus Supply Voltage

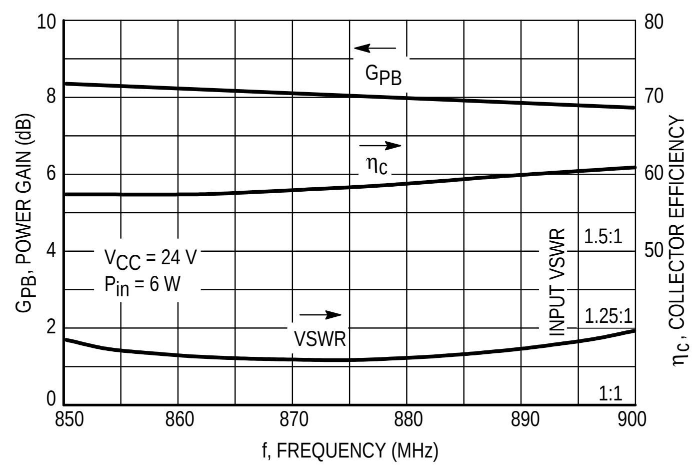
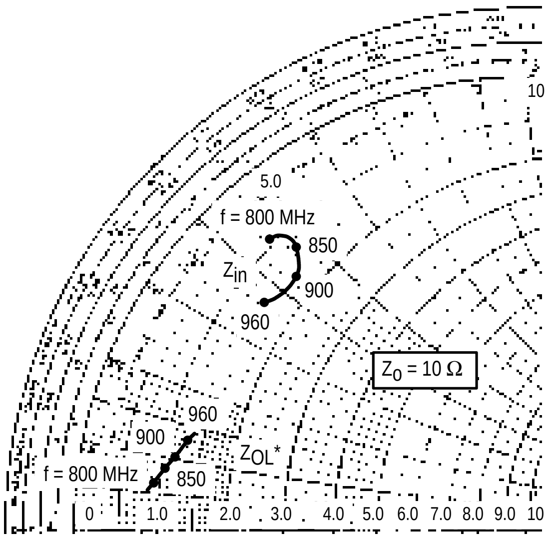


Figure 5. Typical Broadband Circuit Performance



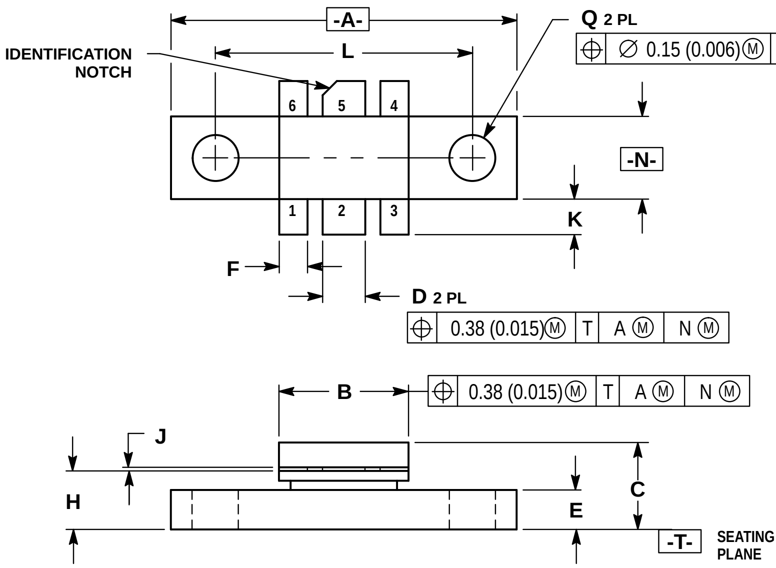
V_{CC} = 24 Vdc, P_{out} = 30 W

f Frequency MHz	Z_{in} Ohms	Z_{OL}* Ohms
800	0.9 + j4.5	1.0 + j0.7
850	1.3 + j4.7	1.1 + j0.9
900	1.6 + j4.4	1.2 + j1.1
960	1.5 + j3.7	1.2 + j1.3

Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 6. Series Equivalent Impedance

PACKAGE DIMENSIONS



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETER	
DIM	MIN	MAX	MIN	MAX
A	0.965	0.985	24.52	25.01
B	0.355	0.375	9.02	9.52
C	0.230	0.260	5.85	6.60
D	0.115	0.125	2.93	3.17
E	0.102	0.114	2.59	2.90
F	0.075	0.085	1.91	2.15
H	0.160	0.170	4.07	4.31
J	0.004	0.006	0.11	0.15
K	0.090	0.110	2.29	2.79
L	0.725 BSC		18.42 BSC	
N	0.225	0.241	5.72	6.12
Q	0.125	0.135	3.18	3.42

STYLE 1:
PIN 1. BASE (COMMON)
2. EMITTER (INPUT)
3. BASE (COMMON)
4. BASE (COMMON)
5. COLLECTOR (OUTPUT)
6. BASE (COMMON)

CASE 319–07
ISSUE M

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